

FIG. 3

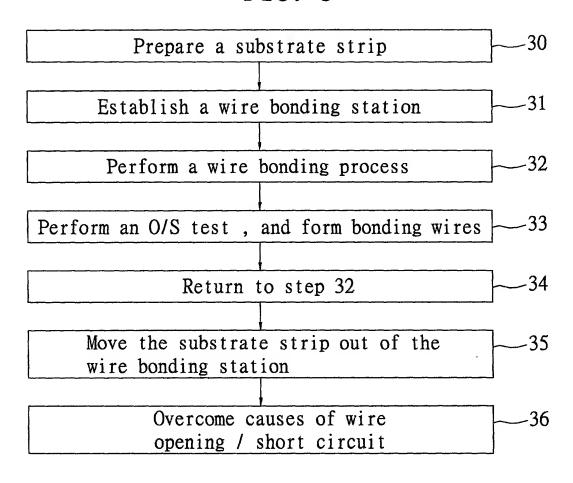
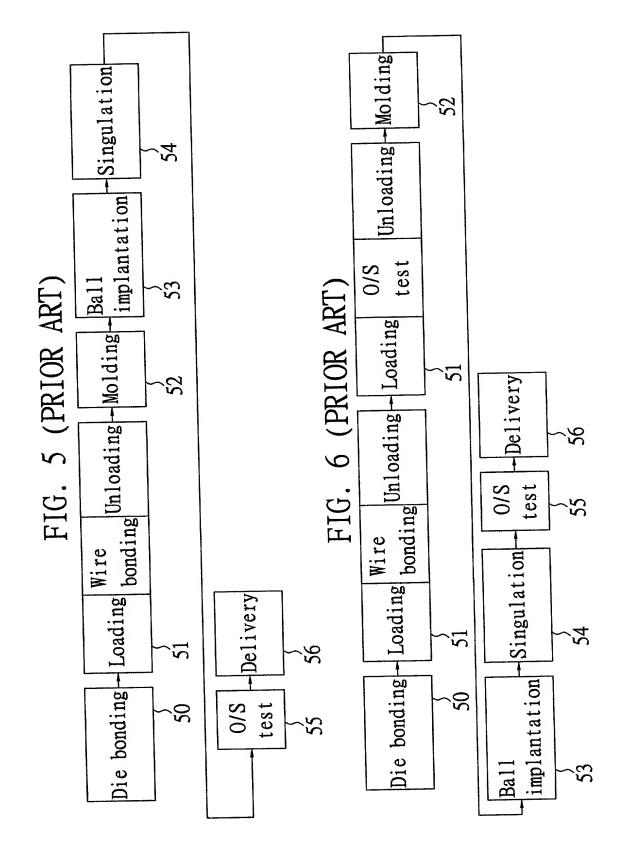


FIG. 4 Prepare a substrate strip Establish a wire bonding station Perform a wire bonding process 44 Perform an O/S test, and form bonding wires Determine Wire opening / No wire opening short circuit short circuit Determine > A command not to A command to interrupt interrupt the the wire bonding process wire bond process Overcome causes of wire opening / short circuit -46 Return to step 43 Return to step 43 Move the substrate -47 Move the substrate strip out of strip out of the wire the wire bonding station, and bonding station overcome causes of wire opening / short circuit



* 4 4